# DATA SHEET

Solid State Relay OCMOS FET

# PS7122A-1B,-2B,PS7122AL-1B,-2B

# 6, 8-PIN DIP, 250 V BREAK DOWN VOLTAGE, NORMALLY CLOSE TYPE 1-ch, 2-ch Optical Coupled MOS FET

## DESCRIPTION

NEC

The PS7122A-1B, -2B and PS7122AL-1B, -2B are solid state relays containing GaAs LEDs on the light emitting side (input side) and normally close (N.C.) contact MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7122AL-1B, -2B have a surface mount type lead.

## FEATURES

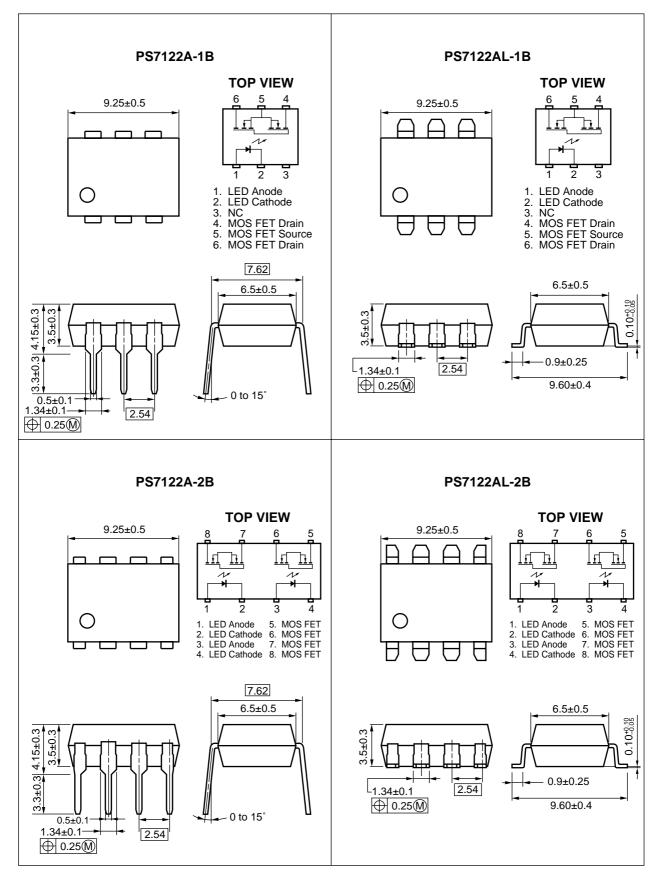
- 1 channel type (1 b output) or 2 channel type (1 b + 1 b output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer
- Small package (6, 8-pin DIP)
- · Low offset voltage
- PS7122AL-1B, -2B: Surface mount type
- UL approved: File No. E72422 (S)
- BSI approved: No. 8245/8246
- CSA approved: No. CA 101391

## **APPLICATIONS**

- Exchange equipment
- Measurement equipment
- FA/OA equipment

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# ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number <sup>*1</sup>
PS7122A-1B	6-pin DIP	Magazine case 50 pcs	PS7122A-1B
PS7122AL-1B			PS7122AL-1B
PS7122AL-1B-E3		Embossed Tape 1 000 pcs/reel	
PS7122AL-1B-E4			
PS7122A-2B	8-pin DIP	Magazine case 50 pcs	PS7122A-2B
PS7122AL-2B			PS7122AL-2B
PS7122AL-2B-E3		Embossed Tape 1 000 pcs/reel	
PS7122AL-2B-E4			

\*1 For the application of the Safety Standard, following part number should be used.

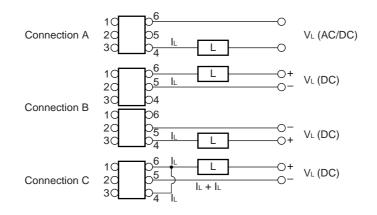
				Rati		
Parameter			Symbol	PS7122A-1B, PS7122AL-1B	PS7122A-2B, PS7122AL-2B	Unit
Diode	Forward Current (D	C)	lf	50		mA
	Reverse Voltage		VR	5.0		V
	Power Dissipation	PD	50		mW/ch	
	Peak Forward Curre	IFP	1		А	
MOS FET	Break Down Voltage		VL	250		V
	Continuous Connection A		lı.	200		mA
	Load Current <sup>*2</sup>	Connection B		350	-	
		Connection C		500	-	
	Pulse Load Current <sup>*3</sup> (AC/DC Connection)		Ilp	400		mA
Power Dissipation		PD	560	375	mW/ch	
Isolation Voltage <sup>*₄</sup>			BV	1 500		Vr.m.s.
Total Power Dissipation			Рт	610	850	mW
Operating Ambient Temperature			TA	-40 to +85		°C
Storage Temperature			Tstg	-40 to +100		°C

# ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

\*

\*1 PW = 100  $\mu$ s, Duty Cycle = 1 %

\*2 Conditions:  $I_F \ge 2$  mA. The following types of load connections are available.



\*3 PW = 100 ms, 1 shot

\*4 AC voltage for 1 minute at  $T_A = 25$  °C, RH = 60 % between input and output

\*

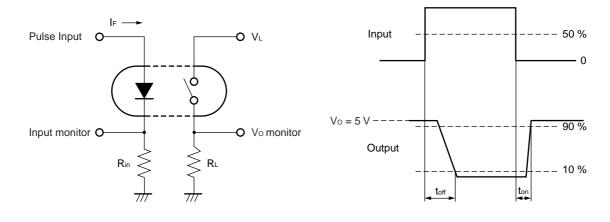
# **RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

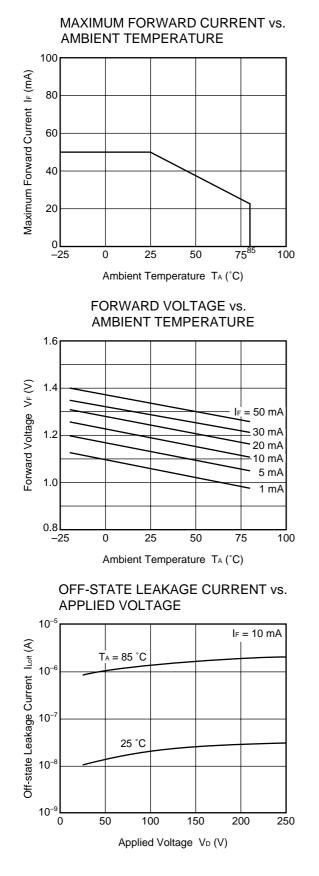
# ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

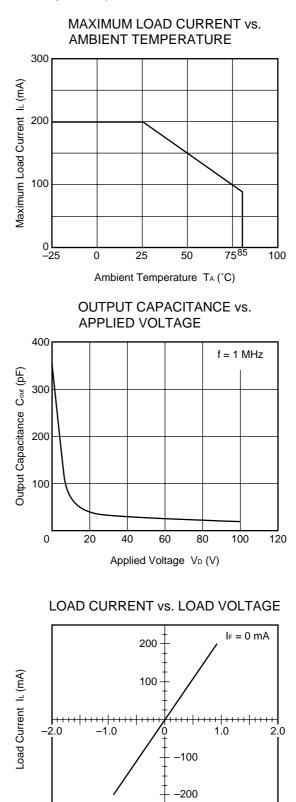
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	Ir	V <sub>R</sub> = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	Loff	IF = 10 mA, VD = 250 V		0.03	1.0	μA
	Output Capacitance	Cout	IF = 10 mA, VD = 0 V, f = 1 MHz		340		pF/ch
Coupled	LED Off-state Current	Foff	I∟ = 200 mA			2.0	mA
	On-state Resistance	Ron1	IF = 0 mA, IL = 10 mA		4.5	8.0	Ω
		Ron2	$I_F=0 \text{ mA}, \ I_L=200 \text{ mA}, \ t \leq 10 \text{ ms}$				
	Turn-on Time <sup>⁺¹</sup>	ton	$I_{F} = 10 \text{ mA}, \text{ V}_{0} = 5 \text{ V}, \text{ R}_{L} = 500 \Omega,$		0.04	0.2	ms
	Turn-off Time <sup>™</sup>	toff	PW ≥ 10 ms		0.5	1.5	
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 <sup>°</sup>			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		1.1		pF/ch

\*1 Test Circuit for Switching Time



# ★ TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise specified)

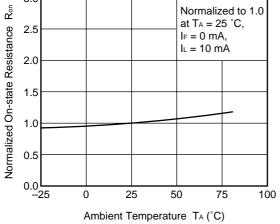




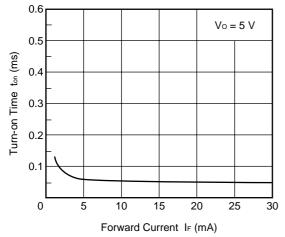
Load Voltage VL (V)

Data Sheet PN10274EJ01V1DS

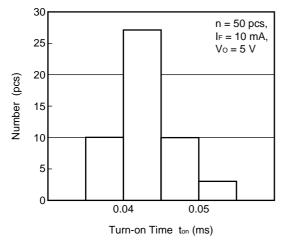
# NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE

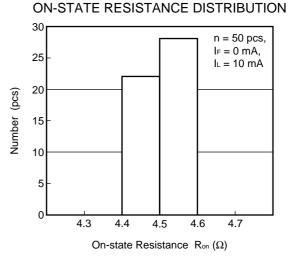


# TURN-ON TIME vs. FORWARD CURRENT

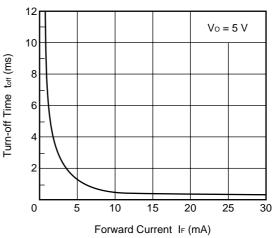


#### TURN-ON TIME DISTRIBUTION

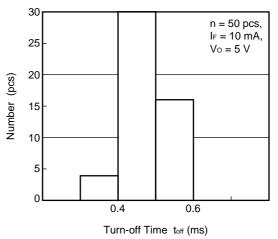


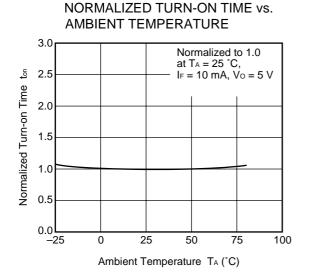


#### TURN-OFF TIME vs. FORWARD CURRENT

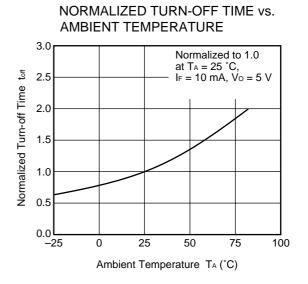


#### TURN-OFF TIME DISTRIBUTION

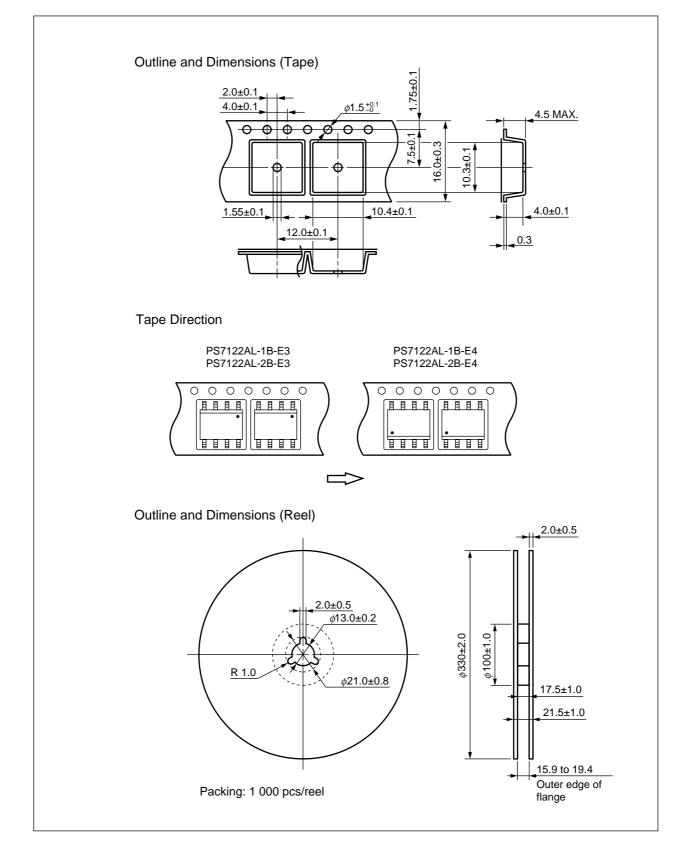




**Remark** The graphs indicate nominal characteristics.



# **\*** TAPING SPECIFICATIONS (in millimeters)

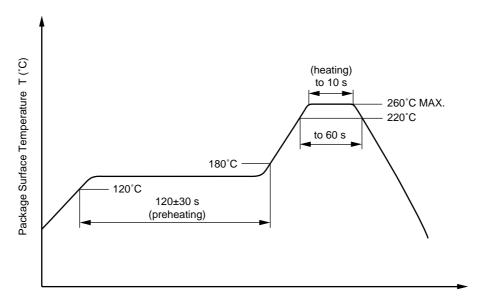


# ★ RECOMMENDED SOLDERING CONDITIONS

- (1) Infrared reflow soldering
  - Peak reflow temperature
  - Time of peak reflow temperature
  - Time of temperature higher than 220°C
  - Time to preheat temperature from 120 to  $180^\circ\text{C}$
  - Number of reflows
  - Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times
   One
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### (3) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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M8E 00.4-0110

#### SAFETY INFORMATION ON THIS PRODUCT

Caution GaAs Products	The product contains gallium arsenide, GaAs. GaAs vapor and powder are hazardous to human health if inhaled or ingested.		
	Do not destroy or burn the product.		
	Do not cut or cleave off any part of the product.		
	Do not crush or chemically dissolve the product.		
	Do not put the product in the mouth.		
	Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.		

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